



SYMBOLS	MIN.	NOM.	MAX.
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	0.203 REF.		
b	0.15	0.20	0.25
D	2.90	3.00	3.10
E	1.90	2.00	2.10
D2	2.40	2.50	2.60
E2	0.80	0.90	1.00
e	0.40 BSC		
L	0.30	0.35	0.40
L1	0.06	0.11	0.16

Notes:

1. All dimensions are in mm. Angles in degrees.
2. Coplanarity applies to the exposed thermal pads as well as the terminals.
3. Recommended land pattern is for reference only.
4. Thermal pad soldering area (Mesh stencil is recommended)



DATE: 06/10/13

DESCRIPTION: 14-Lead, Thin Dual-in-line Flat No-Lead (TDFN)

PACKAGE CODE: ZJ14

DOCUMENT CONTROL #: PD - 2159

REVISION: --